

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the PATENT application of

T.L. Ritzdorf et al

Serial No.: 09/880,715

Filed: June 12, 2001



Examiner: Leader

Group Art Unit: 2823

For: Method for Filling Recessed Micro-Structures with Metallizations in the Production of a Microelectronic Device

NOTICE OF APPEAL FROM THE PRIMARY EXAMINER
TO THE BOARD OF PATENT APPEALS AND INTERFERENCES

RECEIVED

Mail Stop: AF
Commissioner for Patents
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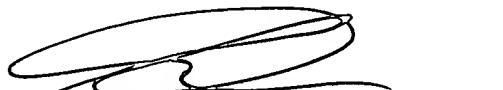
JUL 06 2004
USPTO CENTER 2800

Sir:

Applicant hereby appeals to the Board of Patent Appeals and Interferences from the decision dated December 30, 2003, of the Primary Examiner finally rejecting claims 54-59, all of the claims remaining in the subject application.

Enclosed is Credit Authorization Form PTO-2038 in the amount of \$330.00 for payment of the Notice of Appeal fee.

Respectfully submitted,



Robert H. Epstein
Registration No. 24,353

Epstein & Gerken
1901 Research Blvd., Suite 340
Rockville, Maryland 20850
(301) 610-7634

Hand-Delivered: 6/30/04

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